PD -91884

 I_D

14A



SMPS MOSFET

VDSS

500V

IRFP450A

HEXFET® Power MOSFET

Rds(on) max

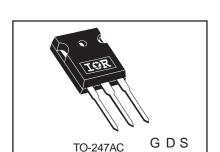
 0.40Ω

Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptable Power Supply
- High speed power switching

Benefits

- Low Gate Charge Qg results in Simple Drive Requirement
- Improved Gate, Avalanche and Dynamic dv/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified (See AN 1001)



Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	14	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	8.7	A
I _{DM}	Pulsed Drain Current ①	56	
P _D @T _C = 25°C	Power Dissipation	190	W
	Linear Derating Factor	1.5	W/°C
V_{GS}	Gate-to-Source Voltage	± 30	V
dv/dt	Peak Diode Recovery dv/dt 3	4.1	V/ns
T _J	Operating Junction and	-55 to + 150	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torqe, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Typical SMPS Topologies:

- Two Transistor Forward
- Half Bridge, Full Bridge
- PFC Boost

Notes ① through ⑤ are on page 8 www.irf.com

International IOR Rectifier

IRFP450A Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	500			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.58		V/°C	Reference to 25°C, I _D = 1mA®
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.40	Ω	V _{GS} = 10V, I _D = 8.4A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
1	Drain-to-Source Leakage Current			25	uА	$V_{DS} = 500V, V_{GS} = 0V$
I _{DSS}	Drain-to-Source Leakage Current			250	μΛ	$V_{DS} = 400V$, $V_{GS} = 0V$, $T_{J} = 125$ °C
1	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 30V
I _{GSS}	Gate-to-Source Reverse Leakage			-100	IIA	$V_{GS} = -30V$

Dynamic @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
9fs	Forward Transconductance	7.8			S	$V_{DS} = 50V, I_D = 8.4A$
Qg	Total Gate Charge			64		I _D = 14A
Q _{gs}	Gate-to-Source Charge			16	nC	$V_{DS} = 400V$
Q _{gd}	Gate-to-Drain ("Miller") Charge			26		V_{GS} = 10V, See Fig. 6 and 13 \oplus
t _{d(on)}	Turn-On Delay Time		15			V _{DD} = 250V
t _r	Rise Time		36		ns	$I_D = 14A$
t _{d(off)}	Turn-Off Delay Time		35			$R_G = 6.2\Omega$
t _f	Fall Time		29			$R_D = 17\Omega$, See Fig. 10 ④
C _{iss}	Input Capacitance		2038			$V_{GS} = 0V$
Coss	Output Capacitance		307			$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		10		pF	f = 1.0MHz, See Fig. 5
Coss	Output Capacitance		2859		1	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
Coss	Output Capacitance		81]	$V_{GS} = 0V$, $V_{DS} = 400V$, $f = 1.0MHz$
Coss eff.	Effective Output Capacitance		96]	V _{GS} = 0V, V _{DS} = 0V to 400V ⑤

Avalanche Characteristics

	Parameter	Тур.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy@		760	mJ
I _{AR}	Avalanche Current®		14	Α
E _{AR}	Repetitive Avalanche Energy①		19	mJ

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case		0.65	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24		°C/W
$R_{\theta JA}$	Junction-to-Ambient		40	

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current	Current		14		MOSFET symbol
	(Body Diode)		14		A	showing the
I _{SM}	Pulsed Source Current				1 ^	integral reverse
	(Body Diode) ①	- 56		p-n junction diode.		
V _{SD}	Diode Forward Voltage			1.4	V	$T_J = 25^{\circ}C$, $I_S = 14A$, $V_{GS} = 0V$ ④
t _{rr}	Reverse Recovery Time		487	731	ns	T _J = 25°C, I _F = 14A
Qrr	Reverse RecoveryCharge		3.9	5.8	μC	$di/dt = 100A/\mu s$ ④
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)				

IRFP450A

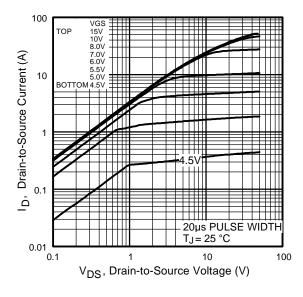


Fig 1. Typical Output Characteristics

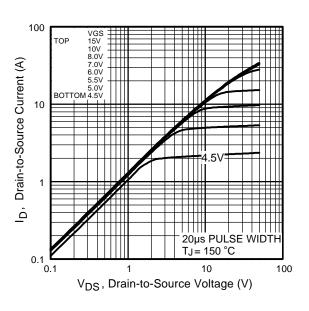


Fig 2. Typical Output Characteristics

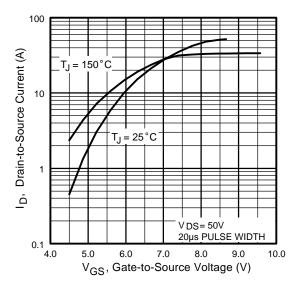


Fig 3. Typical Transfer Characteristics

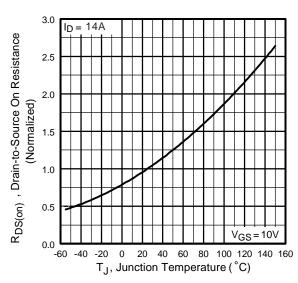


Fig 4. Normalized On-Resistance Vs. Temperature

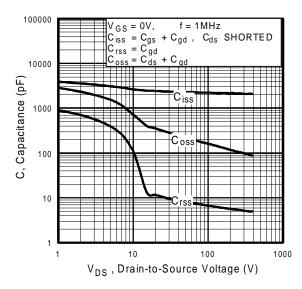


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

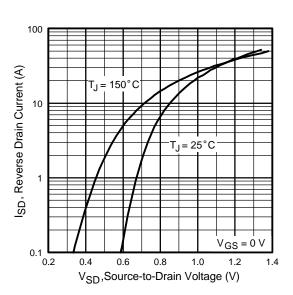


Fig 7. Typical Source-Drain Diode Forward Voltage

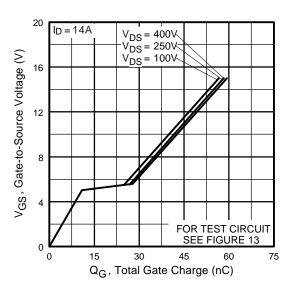


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

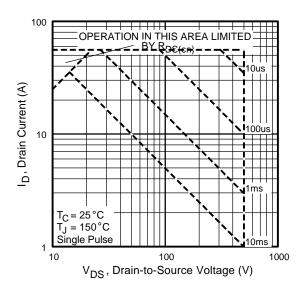


Fig 8. Maximum Safe Operating Area

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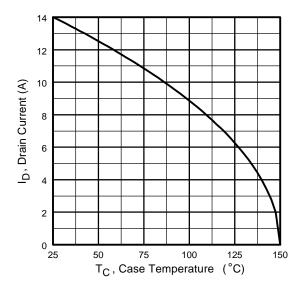


Fig 9. Maximum Drain Current Vs. Case Temperature

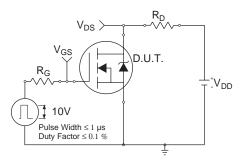


Fig 10a. Switching Time Test Circuit

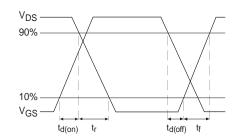


Fig 10b. Switching Time Waveforms

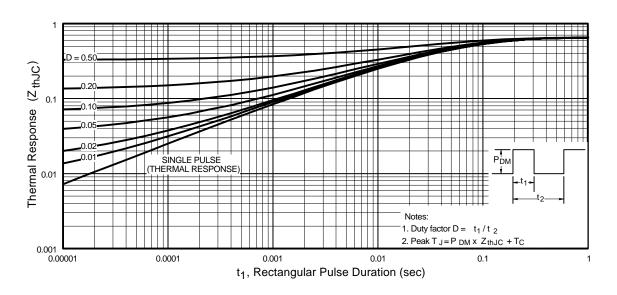


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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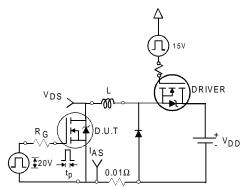


Fig 12a. Unclamped Inductive Test Circuit

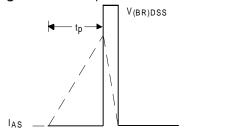


Fig 12b. | Unclamped Inductive Waveforms

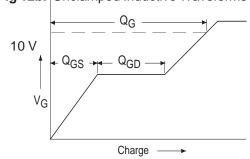


Fig 13a. Basic Gate Charge Waveform

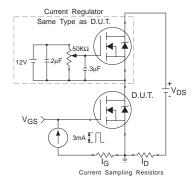


Fig 13b. Gate Charge Test Circuit

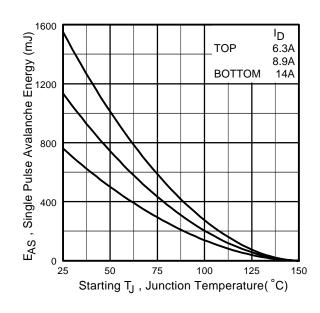


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

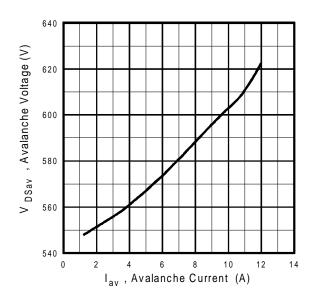
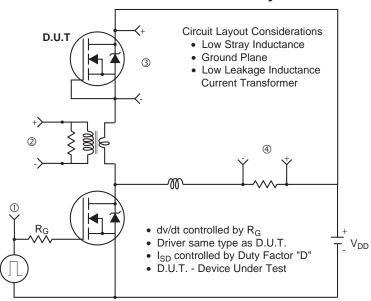


Fig 12d. Typical Drain-to-Source Voltage Vs. Avalanche Current

Peak Diode Recovery dv/dt Test Circuit



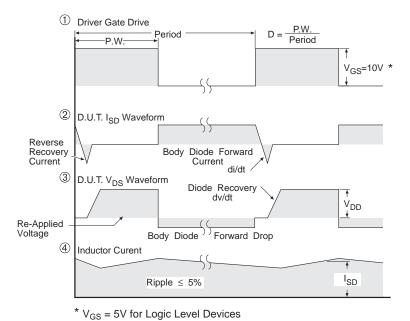


Fig 14. For N-Channel HEXFETS

IRFP450A

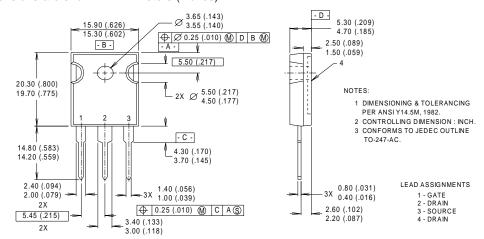
International

Rectifier

Package Outline

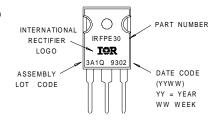
TO-247AC Outline

Dimensions are shown in millimeters (inches)



Part Marking Information TO-247AC

EXAMPLE: THIS IS AN IRFPE30 WITH ASSEMBLY LOT CODE 3A1Q



Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- ② Starting $T_J = 25$ °C, L =7.8mH $R_G = 25\Omega$, $I_{AS} = 14A$. (See Figure 12)
- $\begin{tabular}{l} \begin{tabular}{l} \begin{tab$
- 4 Pulse width $\leq 300 \mu s$; duty cycle $\leq 2\%$.
- $^{\circ}$ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}



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